SPECIFICATION FOR LCD MODULE

Model No.   **TM24064QBCWU6**

Prepared by:	Date:
Checked by :	Date:
Verified by :	Date:
Approved by:	Date:

TIANMA MICROELECTRONICS CO., LTD

Ver 1.0

REVISION RECORD

Date	Ver.	Ref. Page	Revision No.	Revision Items
2003/7/21	V1.0			Preliminary specification

1. General Specifications:
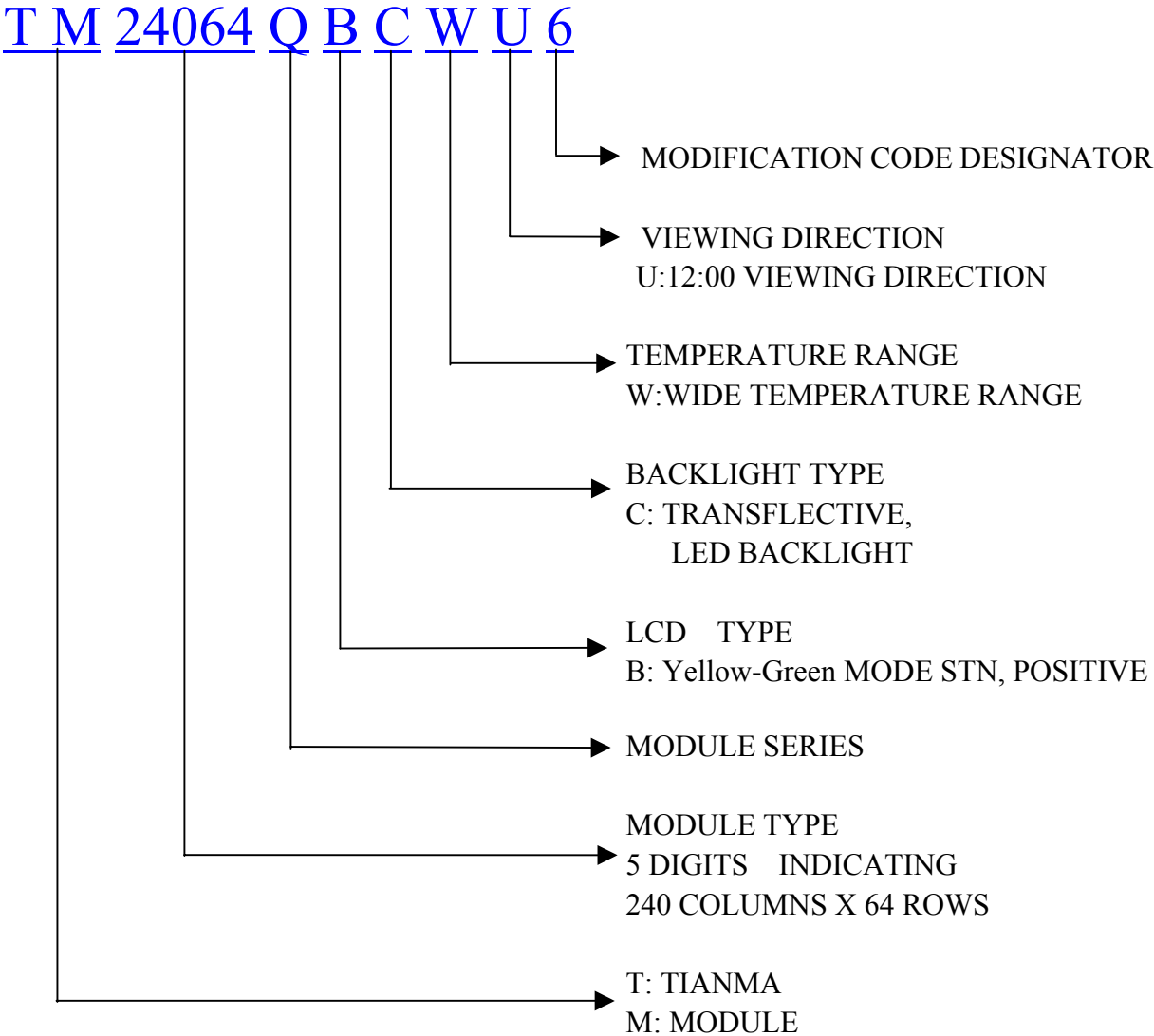
1.1 Display type: STN/Yellow-Green MODE

1.2 Display color*:

      Display color: Blue-Black

      Background: Yellow-Green

1.3 Polarizer mode: Transflective/Positive

1.4 Viewing Angle: 12:00

1.5 Driving Method: 1/64 Duty 1/9 Bias

1.6 Backlight: LED(Yellow-Green ,4.2V)

1.7 Controller: S6B0108A01-C0CX

1.8 Data Transfer: 8 Bit Parallel

1.9 Operating Temperature: -20----+70℃

     Storage Temperature: -30----+80℃

1.10 Outline Dimensions: Refer to outline drawing on next page

1.11 Dot Matrix: 240 X 64 Dots

1.12 Dot Size: 0.34X0.34(mm)

1.13 Dot Pitch: 0.37X0.37 (mm)

1.14 Weight: Approx. 100g

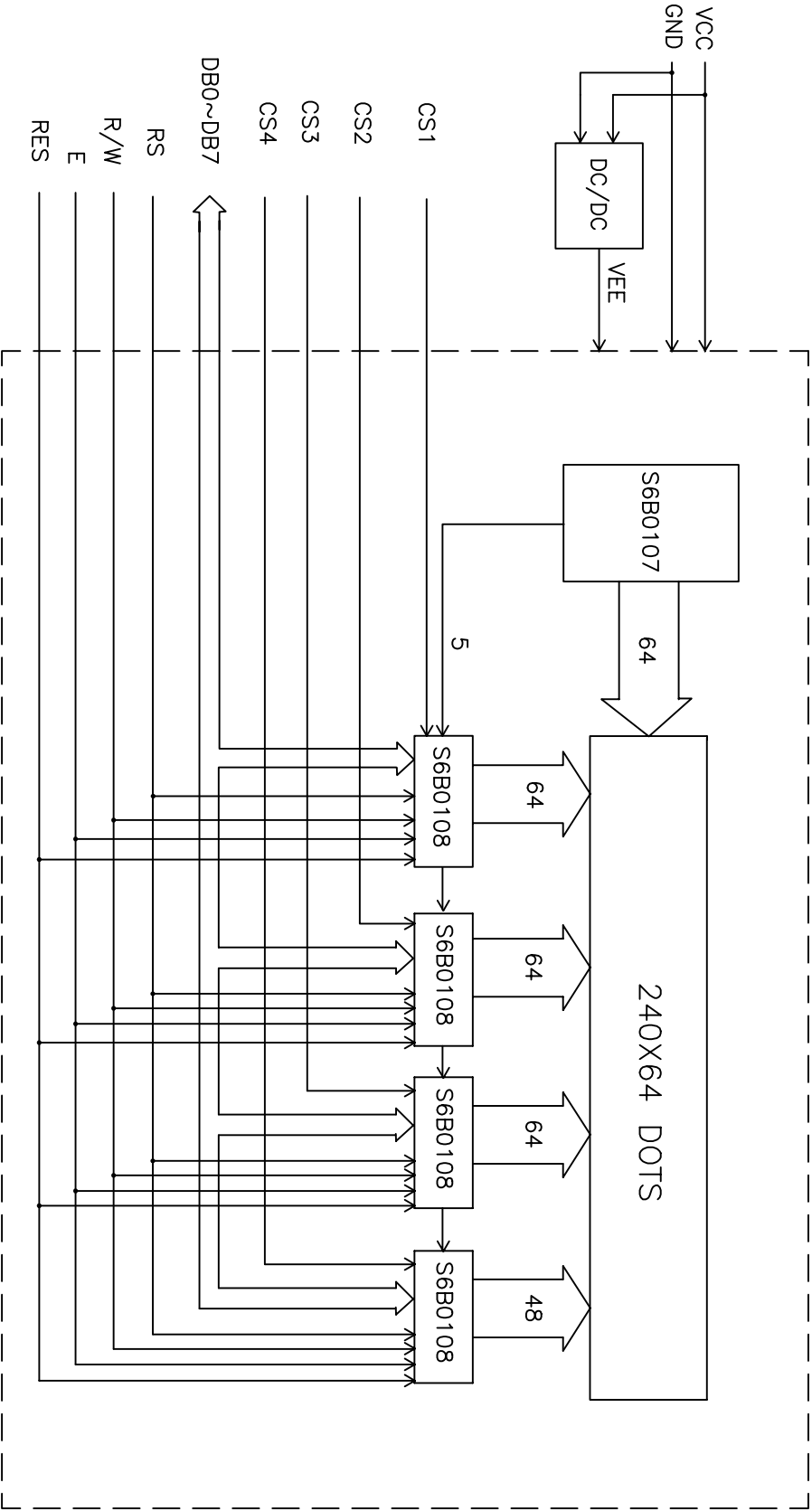   * Color tone is slightly changed by temperature and driving voltage.

2. Outline Drawing

DETAIL A:

240X64 DOTS

NOTES:
1. DISPLAY TYPE: STN/YELLOW MODE
2. VIEWING DIRECTION: 12:00
3. POLARIZER MODE: TRANSFLECTIVE/POSITIVE
4. DRIVE METHED: 1/64 DUTY 1/9 BIAS
5. LCD OPERATING VOLTAGE: 11.0V
6. OPERATING TEMP: -20°C~+70°C
7. STORAGE TEMP: -30°C~+80°C
8. CONTROLLER: S6B0108A01-C0CX
9. BACKLIGHT: LED
10. BEZEL IS TO BE PAINTED BLACK
11. UNMARKED TOLERANCE: ±0.3mm

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
VSS	VDD	RS	R/W	E	D7	D6	D5	D4	D3	D2	D1	D0	CS1	CS2	CS3	CS4	RES	K	A

TIAN-MA MICROELECTRONICS CO.

6/F., CASTIC Building, Shennan Road, Central, Shenzhen, China

DRAWN BY:		TITLE: TM240640BCWU6	
CHECKED BY:			
APPROVED BY:		DWG NO: G-1	SCALE:
CONFIRMED BY:		DWG NAME: TM240640BCWU6G-1	SHEET NO: 1 OF 1 · UNIT: mm

3. LCD Module Part Numbering System

T M 24064 Q B C W U 6

→ MODIFICATION CODE DESIGNATOR

→ VIEWING DIRECTION
U:12:00 VIEWING DIRECTION

→ TEMPERATURE RANGE
W:WIDE TEMPERATURE RANGE

→ BACKLIGHT TYPE
C: TRANSFLECTIVE,
   LED BACKLIGHT

→ LCD   TYPE
B: Yellow-Green MODE STN, POSITIVE

→ MODULE SERIES

→ MODULE TYPE
5 DIGITS   INDICATING
240 COLUMNS X 64 ROWS

→ T: TIANMA
M: MODULE

4. Circuit Block Diagram

5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remark
Power Supply Voltage	$V_{DD}-V_{SS}$	-0.3	6.0	V	
LCD Driving Voltage	V_{LCD}	-	25.0		
Operating Temperature Range	T_{OP}	-20	+70	℃	No Condensation
Storage Temperature Range	T_{ST}	-30	+80		

6. Electrical Specifications and Instruction Code

6.1 Electrical characteristics

Item		Symbol	Min.	Typ.	Max.	Unit
Supply Voltage (Logic)		$V_{DD}-V_{SS}$	4.75	5.0	5.25	V
Supply Voltage (LCD Drive)		V_{LCD}	-	11.0	-	V
Input Signal Voltage	High	V_{IH} （V_{DD}=5.0）	$0.8V_{DD}$	-	V_{DD}+0.3	V
	Low	V_{IL} （V_{DD}=5.0）	0	-	$0.2V_{DD}$	V
Supply current (Logic)		I_{DD}	-	-	8.0	mA
Supply current (LCD Drive)		I_{EE}	-	-	3.0	mA
Supply current (LED Drive)		I_{LED}	-	430	-	mA

6.2 Interface Signals

Pin No.	Symbol	Level	Description
1	VSS	0V	Ground
2	VDD	5.0V	Power supply voltage for logic and LCD(+)
3	RS	H/L	Selects registers
4	R/$\overline{W}$	H/L	Selects read or write
5	E	H/L	Starts data read/write
6	DB7	H/L	Data bit7
7	DB6	H/L	Data bit6
8	DB5	H/L	Data bit5
9	DB4	H/L	Data bit4
10	DB3	H/L	Data bit3
11	DB2	H/L	Data bit2
12	DB1	H/L	Data bit1
13	DB0	H/L	Data bit0
14	$\overline{CS1}$	H/L	Chip (U1) Enable Signal (active at low)
15	$\overline{CS2}$	H/L	Chip (U2) Enable Signal (active at low)
16	$\overline{CS3}$	H/L	Chip (U3) Enable Signal (active at low)
17	$\overline{CS4}$	H/L	Chip (U4) Enable Signal (active at low)
18	$\overline{RES}$	H/L	Reset signal (active at low)
19	K	0V	Power supply voltage for LED(-)
20	A	4.2V	Power supply voltage for LED(+)

6.3 Interface Timing Chart

Characteristic	Symbol	Min	Typ	Max	Unit
E Cycle	t_C	1000	-	-	ns
E High Level Width	t_{WH}	450	-	-	ns
E Low Level Width	t_{WL}	450	-	-	ns
E Rise Time	t_R	-	-	25	ns
E Fall Time	t_F	-	-	25	ns
Address Set-Up Time	t_{ASU}	140	-	-	ns
Address Hold Time	t_{AH}	10	-	-	ns
Data Set-Up Time	t_{DSU}	200	-	-	ns
Data Delay Time	t_D	-	-	320	ns
Data Hold Time (Write)	t_{DHW}	10	-	-	ns
Data Hold Time (Read)	t_{DHR}	20	-	-	ns

MPU write timing
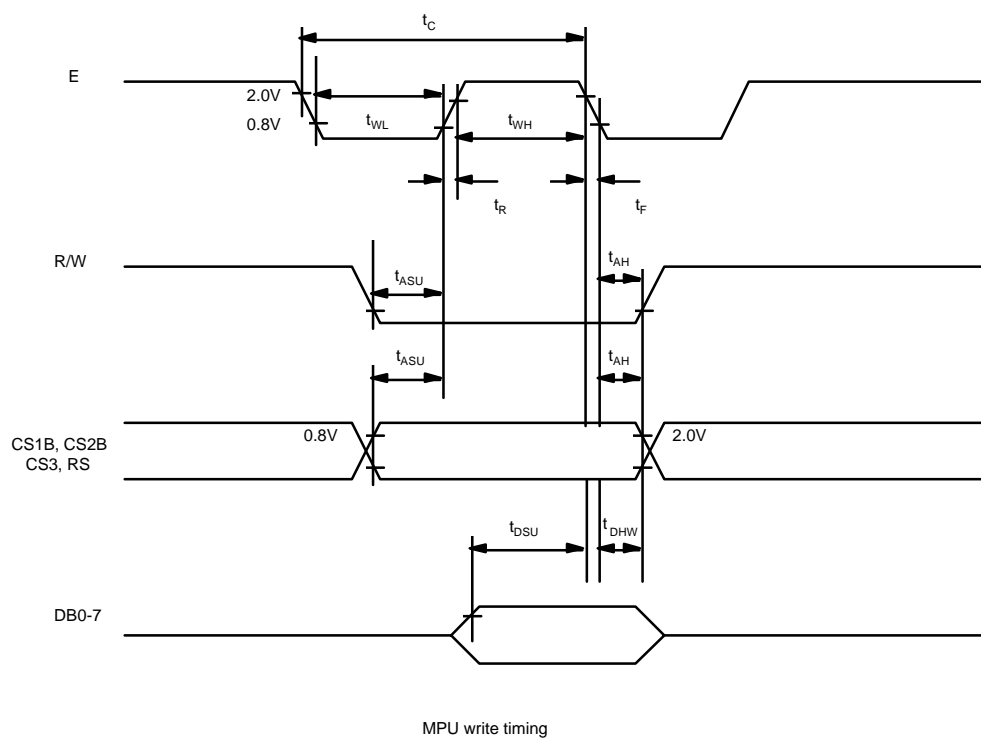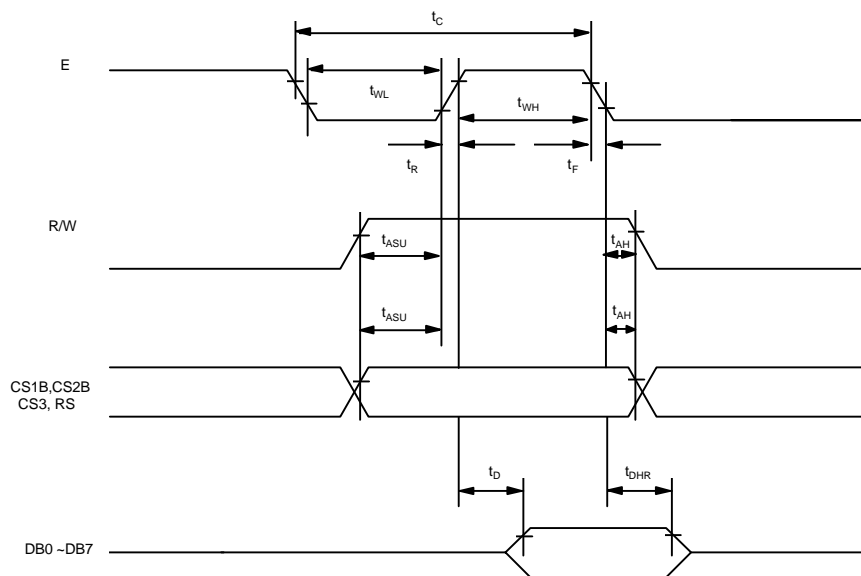
MPU Read timing

6.4 Instruction Code

Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Function
Display ON/OFF	L	L	L	L	H	H	H	H	H	L/H	Controls the display on or off. Internal status and display RAM data is not affected. L:OFF, H:ON
Set Address (Y address)	L	L	L	H			Y address (0~63)				Sets the Y address in the Y address counter.
Set Page (X address)	L	L	H	L	H	H	H		Page (0~7)		Sets the X address at the X address register.
Display Start Line (Z address)	L	L	H	H			Display start line (0~63)				Indicates the display data RAM displayed at the top of the screen.
Status Read	L	H	BUSY	L	ON/OFF	RESET	L	L	L	L	Read status. BUSY　L: Ready　　　H: In operation ON/OFF L: Display ON　　　H: Display OFF RESET　L: Normal　　　H: Reset
Write Display Data	H	L				Write Data					Writes data (DB0:7) into display data RAM. After writing instruction, Y address is increased by 1 automatically.
Read Display Data	H	H				Read Data					Reads data (DB0:7) from display data RAM to the data bus.

7. Optical Characteristics

7.1 Optical Characteristics   Ta=25℃

Item		Symbol	Condition		Min.	Typ.	Max.	Unit
Viewing Angle		θ_x	$C_r{\geq}2$	$\theta_y=0°$	-20	--	30	Deg
		θ_y		$\theta_x=0°$	-30	--	30	
Contrast Ratio		C_r	$\theta_x=0°$ $\theta_y=0°$		3.0	-	-	
Response Time	Turn on	T_{on}	$\theta_x=0°$ $\theta_y=0°$		-	-	300	ms
	Turn off	T_{off}			-	-	300	

7.2 Definition of Optical Characteristics
7.2.1 Definition of Viewing Angle

Top   Top

Bottom   Bottom
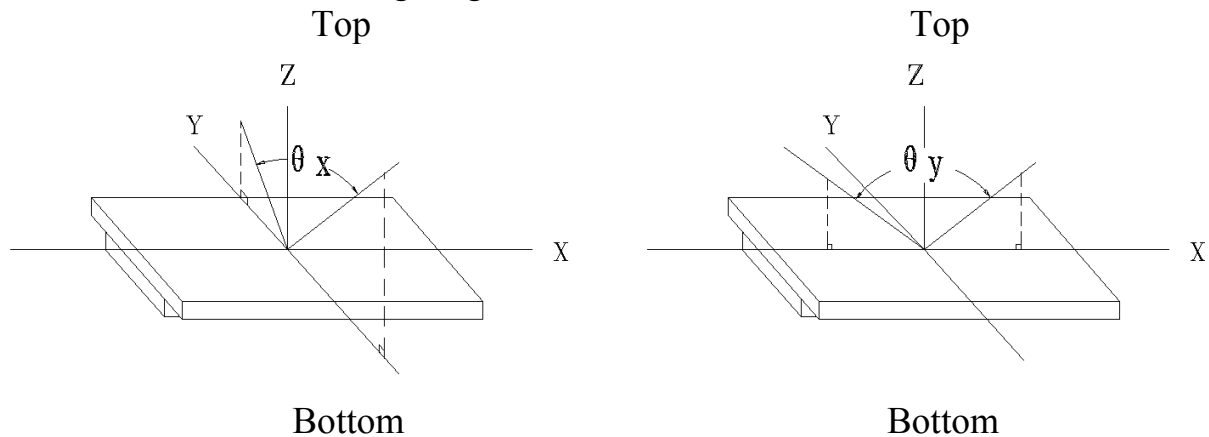
7.2.2 Definition of Contrast Ratio
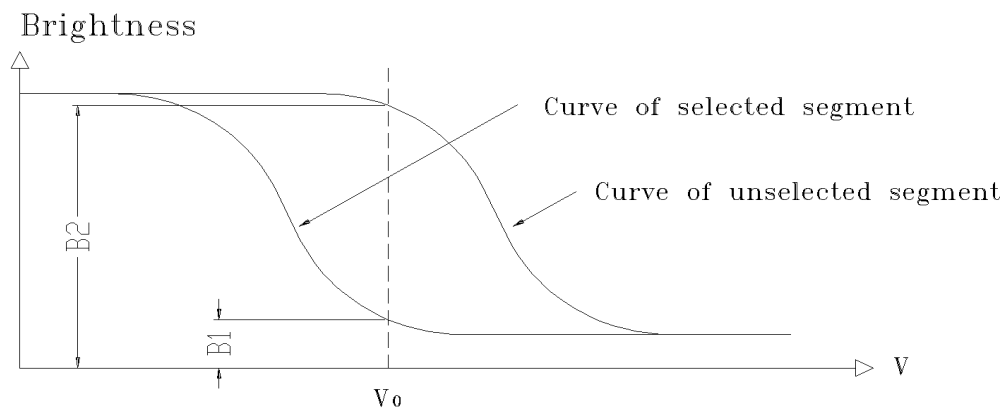
$$\text{Contrast Ratio} = B2/B1 = \frac{\text{unselected state brightness}}{\text{selected state brightness}}$$

Measuring Conditions:

1) Ambient Temperature: 25℃ ; 2) Frame frequency: 70Hz

7.2.3 Definition of Response time
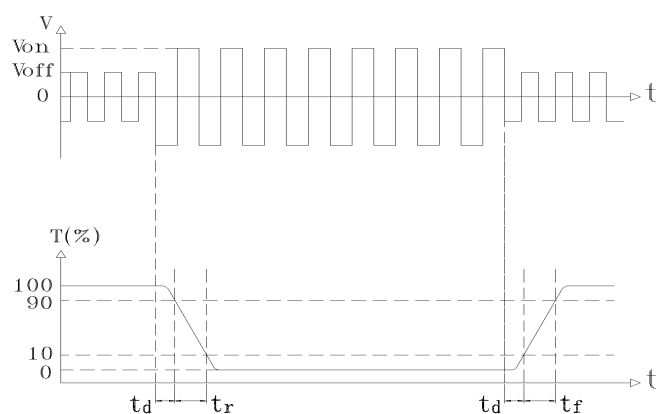
Turn on time: $t_{on} = t_d + t_r$ Turn off time: $t_{off} = t_d + t_f$

Measuring Condition:

1) Operating Voltage: 11.0V   2) Frame frequency: 70Hz

8. Reliability

8.1 Content of Reliability Test   Ta=25℃

No.	Test Item	Content of Test	Test condition
1	High Temperature Storage	Endurance test applying the high storage temperature for a long time	80℃ 240H Restore 4H at 25℃
2	Low Temperature Storage	Endurance test applying the low storage temperature for a long time	-30℃ 240H Restore 4H at 25℃
3	High Temperature /Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time	60℃ 90%RH 240H Restore 4H at 25℃
4	Temperature Cycle	Endurance test applying the low and high temperature cycle -30℃⟷25℃⟷80℃⟷25℃ 30min 5min 30min 5min ⟵———————————⟶ 1 cycle	-30℃/80℃ 10 cycles Restore 4H at 25℃
5	Vibration Test (package state)	Endurance test applying the vibration during transportation	10Hz~500Hz, 100m/s^2, 120min
6	Shock Test (package state)	Endurance test applying the shock during transportation	Half- sine wave, 300m/s^2, 18ms
7	Atmospheric Pressure Test	Endurance test applying the atmospheric pressure during transportation by air	25kPa 16H Restore 2H

8.2 Failure Judgment Criterion

Criterion Item	Test Item No.							Failure Judgement Criterion
	1	2	3	4	5	6	7	
Basic Specification	√	√	√	√	√	√	√	Out of the basic Specification
Electrical specification	√	√	√					Out of the electrical specification
Mechanical Specification					√	√		Out of the mechanical specification
Optical Characteristic	√	√	√	√			√	Out of the optical specification
Note	For test item refer to 8.1							
Remark	Basic specification = Optical specification + Mechanical specification							

9. QUALITY LEVEL

Examination or Test	At T_a=25℃ (unless otherwise stated)	Inspection				
		Min.	Max.	Unit	IL	AQL
External Visual Inspection	Under normal illumi-nation and eyesight condition, the dis-tance between eyes and LCD is 25cm.	See Appendix A			II	Major 0.65 Minor 1.5
Display Defects	Under normal illumi-nation and eyesight condition, display on inspection.	See Appendix B			II	Major 0.65 Minor 1.5

Note: Major defects: Open segment or common, Short, Serious damages, Leakage
      Miner defects: Others
      Sampling standard conforms to GB2828						

10. Precautions for Use of LCD Modules

10.1 Handling Precautions

10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.

10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.

10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.

10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.

10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
　　　— Isopropyl alcohol
　　　— Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:
　　　— Water
　　　— Ketone
　　　— Aromatic solvents

10.1.6 Do not attempt to disassemble the LCD Module.

10.1.7 If the logic circuit power is off, do not apply the input signals.

10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

　a. Be sure to ground the body when handling the LCD Modules.

　b. Tools required for assembly, such as soldering irons, must be properly ground.

　c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.

　d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

10.2 Storage precautions

10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.

10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:
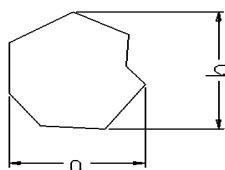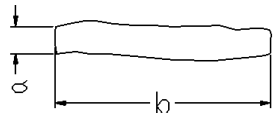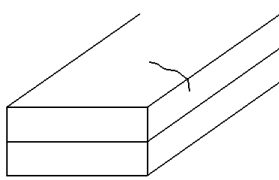
Temperature :　　　　　$0℃ \sim 40℃$

Relatively humidity:　　$≤80\%$

10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.

10.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.
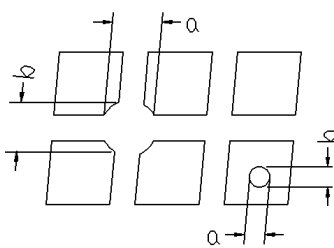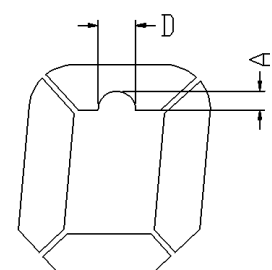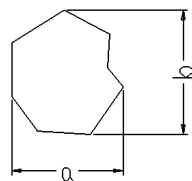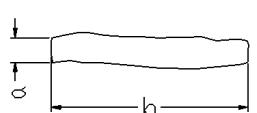
Appendix A

Inspection items and criteria for appearance defects

Items	Contents	Criteria			
Leakage		Not permitted			
Rainbow		According to the limit specimen			
Polarizer	Wrong polarizer attachment	Not permitted			
	Bubble between polarizer and glass	Not counted	Max. 3 defects allowed		
		$\phi<0.3$mm	0.3mm$\leqslant\phi\leqslant0.5$mm		
	Scratches of polarizer	According to the limit specimen			
Black spot (in viewing area)		Not counted	Max. 3 spots allowed		Max. 3 spots (lines) allowed
		X<0.2mm	0.2mm$\leqslant$X$\leqslant0.5$mm		
		X=(a+b)/2			
Black line (in viewing area)		Not counted	Max. 3 lines allowed		
		a<0.02mm	0.02mm$\leqslant$a$\leqslant0.05$mm b$\leqslant2.0$mm		
Progressive cracks		Not permitted			
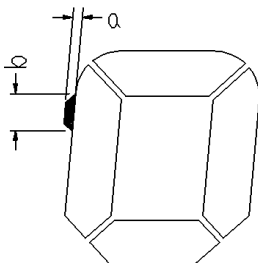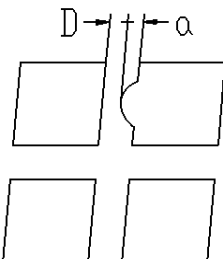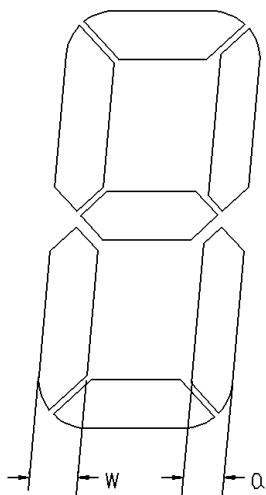
Appendix B
Inspection items and criteria for display defects

Items	Contents	Criteria		
Open segment or open common		Not permitted		
Short		Not permitted		
Wrong viewing angle		Not permitted		
Contrast radio uneven		According to the limit specimen		
Crosstalk		According to the limit specimen		
Pin holes and cracks in segment (DOT)		Not counted	Max.3 dots allowed	Max.3 dots allowed
		X<0.1mm	0.1mm≤X≤0.2mm	
		X=(a+b)/2		
		Not counted	Max.2 dots allowed	
		A<0.1mm	0.1mm≤A≤0.2mm D<0.25mm	
Black spot (in viewing area)		Not counted	Max.3 spots allowed	Max.3 spots (lines) allowed
		X<0.1mm	0.1mm≤X≤0.2mm	
		X=(a+b)/2		
Black line (in viewing area)		Not counted	Max.3 lines allowed	
		a<0.02mm	0.02mm≤a≤0.05mm b≤0.5mm	

Items	Content	Criteria		
Transfor-mation of segment		Not counted	Max. 2 defects allowed	Max.3 defects allowed
		x＜0.1mm	0.1mm≤x≤0.2mm	
		x=(a+b)/2		
		Not counted	Max. 1 defects allowed	
		a＜0.1mm	0.1mm≤a≤0.2mm D>0	
		Max.2 defects allowed 0.8W≤a≤1.2W a=measured value of width W=nominal value of width		